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### Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

#### **Details**

Product Status	Obsolete
Number of LABs/CLBs	13940
Number of Logic Elements/Cells	348500
Total RAM Bits	21270528
Number of I/O	554
Number of Gates	-
Voltage - Supply	0.87V ~ 0.93V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1152-BBGA, FCBGA
Supplier Device Package	1152-FBGA (35x35)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/intel/ep2agz350ff35c4n">https://www.e-xfl.com/product-detail/intel/ep2agz350ff35c4n</a>



Conditions beyond those listed in [Table 1-1](#) and [Table 1-2](#) may cause permanent damage to the device. Additionally, device operation at the absolute maximum ratings for extended periods of time may have adverse effects on the device.

[Table 1-1](#) lists the absolute maximum ratings for Arria II GX devices.

**Table 1-1. Absolute Maximum Ratings for Arria II GX Devices**

Symbol	Description	Minimum	Maximum	Unit
$V_{CC}$	Supplies power to the core, periphery, I/O registers, PCI Express® (PIPE) (PCIe) HIP block, and transceiver PCS	-0.5	1.35	V
$V_{CCCB}$	Supplies power for the configuration RAM bits	-0.5	1.8	V
$V_{CCBAT}$	Battery back-up power supply for design security volatile key register	-0.5	3.75	V
$V_{CCPD}$	Supplies power to the I/O pre-drivers, differential input buffers, and MSEL circuitry	-0.5	3.75	V
$V_{CCIO}$	Supplies power to the I/O banks	-0.5	3.9	V
$V_{CCD\_PLL}$	Supplies power to the digital portions of the PLL	-0.5	1.35	V
$V_{CCA\_PLL}$	Supplies power to the analog portions of the PLL and device-wide power management circuitry	-0.5	3.75	V
$V_I$	DC input voltage	-0.5	4.0	V
$I_{OUT}$	DC output current, per pin	-25	40	mA
$V_{CCA}$	Supplies power to the transceiver PMA regulator	—	3.75	V
$V_{CCL\_GXB}$	Supplies power to the transceiver PMA TX, PMA RX, and clocking	—	1.21	V
$V_{CCH\_GXB}$	Supplies power to the transceiver PMA output (TX) buffer	—	1.8	V
$T_J$	Operating junction temperature	-55	125	°C
$T_{STG}$	Storage temperature (no bias)	-65	150	°C

[Table 1-2](#) lists the absolute maximum ratings for Arria II GZ devices.

**Table 1-2. Absolute Maximum Ratings for Arria II GZ Devices (Part 1 of 2)**

Symbol	Description	Minimum	Maximum	Unit
$V_{CC}$	Supplies power to the core, periphery, I/O registers, PCIe HIP block, and transceiver PCS	-0.5	1.35	V
$V_{CCCB}$	Power supply to the configuration RAM bits	-0.5	1.8	V
$V_{CCPGM}$	Supplies power to the configuration pins	-0.5	3.75	V
$V_{CCAUX}$	Auxiliary supply	-0.5	3.75	V
$V_{CCBAT}$	Supplies battery back-up power for design security volatile key register	-0.5	3.75	V
$V_{CCPD}$	Supplies power to the I/O pre-drivers, differential input buffers, and MSEL circuitry	-0.5	3.75	V
$V_{CCIO}$	Supplies power to the I/O banks	-0.5	3.9	V
$V_{CC\_CLKIN}$	Supplies power to the differential clock input	-0.5	3.75	V
$V_{CCD\_PLL}$	Supplies power to the digital portions of the PLL	-0.5	1.35	V
$V_{CCA\_PLL}$	Supplies power to the analog portions of the PLL and device-wide power management circuitry	-0.5	3.75	V
$V_I$	DC input voltage	-0.5	4.0	V
$I_{OUT}$	DC output current, per pin	-25	40	mA

**Table 1–6. Recommended Operating Conditions for Arria II GZ Devices (*Note 6*) (Part 2 of 2)**

Symbol	Description	Condition	Minimum	Typical	Maximum	Unit
$V_{CCL\_GXBLn}$ <i>(3)</i>	Transceiver clock power (left side)	—	1.05	1.1	1.15	V
$V_{CCL\_GXBRn}$ <i>(3)</i>	Transceiver clock power (right side)	—	1.05	1.1	1.15	V
$V_{CCH\_GXBLn}$ <i>(3)</i>	Transmitter output buffer power (left side)	—				
$V_{CCH\_GXBRn}$ <i>(3)</i>	Transmitter output buffer power (right side)	—	1.33/1.425	1.4/1.5 <i>(5)</i>	1.575	V
$T_J$	Operating junction temperature	Commercial	0	—	85	°C
		Industrial	-40	—	100	°C
$t_{RAMP}$	Power supply ramp time	Normal POR (PORSEL=0)	0.05	—	100	ms
		Fast POR (PORSEL=1)	0.05	—	4	ms

**Notes to Table 1–6:**

- (1) Altera recommends a 3.0-V nominal battery voltage when connecting  $V_{CCBAT}$  to a battery for volatile key backup. If you do not use the volatile security key, you may connect the  $V_{CCBAT}$  to either GND or a 3.0-V power supply.
- (2)  $V_{CCPD}$  must be 2.5 V when  $V_{CCIO}$  is 2.5, 1.8, 1.5, or 1.2 V.  $V_{CCPD}$  must be 3.0 V when  $V_{CCIO}$  is 3.0 V.
- (3)  $n = 0, 1,$  or  $2.$
- (4)  $V_{CCA\_L/R}$  must be connected to a 3.0-V supply if the clock multiplier unit (CMU) phase-locked loop (PLL), receiver clock data recovery (CDR), or both, are configured at a base data rate > 4.25 Gbps. For data rates up to 4.25 Gbps, you can connect  $V_{CCA\_L/R}$  to either 3.0 V or 2.5 V.
- (5)  $V_{CCH\_GXBL/R}$  must be connected to a 1.4-V supply if the transmitter channel data rate is > 6.5 Gbps. For data rates up to 6.5 Gbps, you can connect  $V_{CCH\_GXBL/R}$  to either 1.4 V or 1.5 V.
- (6) Transceiver power supplies do not have power-on-reset (POR) circuitry. After initial power-up, violating the transceiver power supply operating conditions could lead to unpredictable link behavior.

## DC Characteristics

This section lists the supply current, I/O pin leakage current, on-chip termination (OCT) accuracy and variation, input pin capacitance, internal weak pull-up and pull-down resistance, hot socketing, and Schmitt trigger input specifications.

### Supply Current

Standby current is the current the device draws after the device is configured with no inputs or outputs toggling and no activity in the device. Because these currents vary largely with the resources used, use the Microsoft Excel-based Early Power Estimator (EPE) to get supply current estimates for your design.

 For more information about power estimation tools, refer to the *PowerPlay Early Power Estimator User Guide* and the *PowerPlay Power Analysis* chapter.

The calibration accuracy for calibrated series and parallel OCTs are applicable at the moment of calibration. When process, voltage, and temperature (PVT) conditions change after calibration, the tolerance may change.

Table 1–13 lists the Arria II GZ OCT without calibration resistance tolerance to PVT changes.

**Table 1–13. OCT Without Calibration Resistance Tolerance Specifications for Arria II GZ Devices**

<b>Symbol</b>	<b>Description</b>	<b>Conditions (V)</b>	<b>Resistance Tolerance</b>		<b>Unit</b>
			<b>C3,I3</b>	<b>C4,I4</b>	
25- $\Omega$ $R_S$ 3.0 and 2.5	25- $\Omega$ internal series OCT without calibration	$V_{CCIO} = 3.0, 2.5$	$\pm 40$	$\pm 40$	%
25- $\Omega$ $R_S$ 1.8 and 1.5	25- $\Omega$ internal series OCT without calibration	$V_{CCIO} = 1.8, 1.5$	$\pm 40$	$\pm 40$	%
25- $\Omega$ $R_S$ 1.2	25- $\Omega$ internal series OCT without calibration	$V_{CCIO} = 1.2$	$\pm 50$	$\pm 50$	%
50- $\Omega$ $R_S$ 3.0 and 2.5	50- $\Omega$ internal series OCT without calibration	$V_{CCIO} = 3.0, 2.5$	$\pm 40$	$\pm 40$	%
50- $\Omega$ $R_S$ 1.8 and 1.5	50- $\Omega$ internal series OCT without calibration	$V_{CCIO} = 1.8, 1.5$	$\pm 40$	$\pm 40$	%
50- $\Omega$ $R_S$ 1.2	50- $\Omega$ internal series OCT without calibration	$V_{CCIO} = 1.2$	$\pm 50$	$\pm 50$	%
100- $\Omega$ $R_D$ 2.5	100- $\Omega$ internal differential OCT	$V_{CCIO} = 2.5$	$\pm 25$	$\pm 25$	%

OCT calibration is automatically performed at power up for OCT-enabled I/Os. When voltage and temperature conditions change after calibration, the resistance may change. Use Equation 1–1 and Table 1–14 to determine the OCT variation when voltage and temperature vary after power-up calibration for Arria II GX and GZ devices.

#### Equation 1–1. OCT Variation (*Note 1*)

$$R_{OCT} = R_{SCAL} \left( 1 + \langle \frac{dR}{dT} \times \Delta T \rangle \pm \langle \frac{dR}{dV} \times \Delta V \rangle \right)$$

##### Notes to Equation 1–1:

- (1)  $R_{OCT}$  value calculated from Equation 1–1 shows the range of OCT resistance with the variation of temperature and  $V_{CCIO}$ .

Use the following with [Equation 1-1](#):

- $R_{SCAL}$  is the OCT resistance value at power up.
- $\Delta T$  is the variation of temperature with respect to the temperature at power up.
- $\Delta V$  is the variation of voltage with respect to the  $V_{CCIO}$  at power up.
- $dR/dT$  is the percentage change of  $R_{SCAL}$  with temperature.
- $dR/dV$  is the percentage change of  $R_{SCAL}$  with voltage.

[Table 1-14](#) lists the OCT variation with temperature and voltage after power-up calibration for Arria II GX devices.

**Table 1-14. OCT Variation after Power-up Calibration for Arria II GX Devices**

Nominal Voltage $V_{CCIO}$ (V)	$dR/dT$ (%/°C)	$dR/dV$ (%/mV)
3.0	0.262	0.035
2.5	0.234	0.039
1.8	0.219	0.086
1.5	0.199	0.136
1.2	0.161	0.288

[Table 1-15](#) lists the OCT variation with temperature and voltage after power-up calibration for Arria II GZ devices.

**Table 1-15. OCT Variation after Power-Up Calibration for Arria II GZ Devices (Note 1)**

Nominal Voltage, $V_{CCIO}$ (V)	$dR/dT$ (%/°C)	$dR/dV$ (%/mV)
3.0	0.189	0.0297
2.5	0.208	0.0344
1.8	0.266	0.0499
1.5	0.273	0.0744
1.2	0.317	0.1241

#### Note to Table 1-15:

(1) Valid for  $V_{CCIO}$  range of  $\pm 5\%$  and temperature range of 0° to 85°C.

#### Pin Capacitance

[Table 1-16](#) lists the pin capacitance for Arria II GX devices.

**Table 1-16. Pin Capacitance for Arria II GX Devices**

Symbol	Description	Typical	Unit
$C_{IO}$	Input capacitance on I/O pins, dual-purpose pins (differential I/O, clock, $R_{up}$ , $R_{dn}$ ), and dedicated clock input pins	7	pF

Table 1–17 lists the pin capacitance for Arria II GZ devices.

**Table 1–17. Pin Capacitance for Arria II GZ Devices**

Symbol	Description	Typical	Unit
$C_{IOTB}$	Input capacitance on the top and bottom I/O pins	4	pF
$C_{IOLR}$	Input capacitance on the left and right I/O pins	4	pF
$C_{CLKTB}$	Input capacitance on the top and bottom non-dedicated clock input pins	4	pF
$C_{CLKLR}$	Input capacitance on the left and right non-dedicated clock input pins	4	pF
$C_{OUTFB}$	Input capacitance on the dual-purpose clock output and feedback pins	5	pF
$C_{CLK1}, C_{CLK3}, C_{CLK8},$ <i>and</i> $C_{CLK10}$	Input capacitance for dedicated clock input pins	2	pF

#### Internal Weak Pull-Up and Weak Pull-Down Resistors

Table 1–18 lists the weak pull-up and pull-down resistor values for Arria II GX devices.

**Table 1–18. Internal Weak Pull-up and Weak Pull-Down Resistors for Arria II GX Devices (Note 1)**

Symbol	Description	Conditions	Min	Typ	Max	Unit
$R_{PU}$	Value of I/O pin pull-up resistor before and during configuration, as well as user mode if the programmable pull-up resistor option is enabled.	$V_{CCIO} = 3.3 V \pm 5\% \text{ (2)}$	7	25	41	kΩ
		$V_{CCIO} = 3.0 V \pm 5\% \text{ (2)}$	7	28	47	kΩ
		$V_{CCIO} = 2.5 V \pm 5\% \text{ (2)}$	8	35	61	kΩ
		$V_{CCIO} = 1.8 V \pm 5\% \text{ (2)}$	10	57	108	kΩ
		$V_{CCIO} = 1.5 V \pm 5\% \text{ (2)}$	13	82	163	kΩ
		$V_{CCIO} = 1.2 V \pm 5\% \text{ (2)}$	19	143	351	kΩ
$R_{PD}$	Value of TCK pin pull-down resistor	$V_{CCIO} = 3.3 V \pm 5\%$	6	19	29	kΩ
		$V_{CCIO} = 3.0 V \pm 5\%$	6	22	32	kΩ
		$V_{CCIO} = 2.5 V \pm 5\%$	6	25	42	kΩ
		$V_{CCIO} = 1.8 V \pm 5\%$	7	35	70	kΩ
		$V_{CCIO} = 1.5 V \pm 5\%$	8	50	112	kΩ

**Notes to Table 1–18:**

- (1) All I/O pins have an option to enable weak pull-up except configuration, test, and JTAG pins. The weak pull-down feature is only available for JTAG TCK.
- (2) Pin pull-up resistance values may be lower if an external source drives the pin higher than  $V_{CCIO}$ .

## I/O Standard Specifications

**Table 1–22** through **Table 1–35** list input voltage ( $V_{IH}$  and  $V_{IL}$ ), output voltage ( $V_{OH}$  and  $V_{OL}$ ), and current drive characteristics ( $I_{OH}$  and  $I_{OL}$ ) for various I/O standards supported by the Arria II device family. They also show the Arria II device family I/O standard specifications.  $V_{OL}$  and  $V_{OH}$  values are valid at the corresponding  $I_{OH}$  and  $I_{OL}$ , respectively.



For an explanation of terms used in **Table 1–22** through **Table 1–35**, refer to “[Glossary](#)” on page [1–74](#).

**Table 1–22** lists the single-ended I/O standards for Arria II GX devices.

**Table 1–22. Single-Ended I/O Standards for Arria II GX Devices**

I/O Standard	$V_{CCIO}$ (V)			$V_{IL}$ (V)		$V_{IH}$ (V)		$V_{OL}$ (V)	$V_{OH}$ (V)	$I_{OL}$ (mA)	$I_{OH}$ (mA)
	Min	Typ	Max	Min	Max	Min	Max	Max	Min		
3.3 V LVTTL	3.135	3.3	3.465	-0.3	0.8	1.7	3.6	0.45	2.4	4	-4
3.3 V LVCMOS	3.135	3.3	3.465	-0.3	0.8	1.7	3.6	0.2	$V_{CCIO} - 0.2$	2	-2
3.0 V LVTTL	2.85	3	3.15	-0.3	0.8	1.7	$V_{CCIO} + 0.3$	0.45	2.4	4	-4
3.0 V LVCMOS	2.85	3	3.15	-0.3	0.8	1.7	$V_{CCIO} + 0.3$	0.2	$V_{CCIO} - 0.2$	0.1	-0.1
2.5 V LVCMOS	2.375	2.5	2.625	-0.3	0.7	1.7	$V_{CCIO} + 0.3$	0.4	2	1	-1
1.8 V LVCMOS	1.71	1.8	1.89	-0.3	$0.35 \times V_{CCIO}$	$0.65 \times V_{CCIO}$	$V_{CCIO} + 0.3$	0.45	$V_{CCIO} - 0.45$	2	-2
1.5 V LVCMOS	1.425	1.5	1.575	-0.3	$0.35 \times V_{CCIO}$	$0.65 \times V_{CCIO}$	$V_{CCIO} + 0.3$	$0.25 \times V_{CCIO}$	$0.75 \times V_{CCIO}$	2	-2
1.2 V LVCMOS	1.14	1.2	1.26	-0.3	$0.35 \times V_{CCIO}$	$0.65 \times V_{CCIO}$	$V_{CCIO} + 0.3$	$0.25 \times V_{CCIO}$	$0.75 \times V_{CCIO}$	2	-2
3.0-V PCI	2.85	3	3.15	—	$0.3 \times V_{CCIO}$	$0.5 \times V_{CCIO}$	$V_{CCIO} + 0.3$	$0.1 \times V_{CCIO}$	$0.9 \times V_{CCIO}$	1.5	-0.5
3.0-V PCI-X	2.85	3	3.15	—	$0.35 \times V_{CCIO}$	$0.5 \times V_{CCIO}$	$V_{CCIO} + 0.3$	$0.1 \times V_{CCIO}$	$0.9 \times V_{CCIO}$	1.5	-0.5

**Table 1–23** lists the single-ended I/O standards for Arria II GZ devices.

**Table 1–23. Single-Ended I/O Standards for Arria II GZ Devices (Part 1 of 2)**

I/O Standard	$V_{CCIO}$ (V)			$V_{IL}$ (V)		$V_{IH}$ (V)		$V_{OL}$ (V)	$V_{OH}$ (V)	$I_{OL}$ (mA)	$I_{OH}$ (mA)
	Min	Typ	Max	Min	Max	Min	Max	Max	Min		
LVTTL	2.85	3	3.15	-0.3	0.8	1.7	3.6	0.4	2.4	2	-2
LVCMOS	2.85	3	3.15	-0.3	0.8	1.7	3.6	0.2	$V_{CCIO} - 0.2$	0.1	-0.1
2.5 V	2.375	2.5	2.625	-0.3	0.7	1.7	3.6	0.4	2	1	-1
1.8 V	1.71	1.8	1.89	-0.3	$0.35 \times V_{CCIO}$	$0.65 \times V_{CCIO}$	$V_{CCIO} + 0.3$	0.45	$V_{CCIO} - 0.45$	2	-2
1.5 V	1.425	1.5	1.575	-0.3	$0.35 \times V_{CCIO}$	$0.65 \times V_{CCIO}$	$V_{CCIO} + 0.3$	$0.25 \times V_{CCIO}$	$0.75 \times V_{CCIO}$	2	-2

**Table 1–27. Single-Ended SSTL and HSTL I/O Standards Signal Specifications for Arria II GZ Devices (Part 2 of 2)**

I/O Standard	V <sub>IL(DC)</sub> (V)		V <sub>IH(DC)</sub> (V)		V <sub>IL(AC)</sub> (V)	V <sub>IH(AC)</sub> (V)	V <sub>OL</sub> (V)	V <sub>OH</sub> (V)	I <sub>OL</sub> (mA)	I <sub>OH</sub> (mA)
	Min	Max	Min	Max	Max	Min	Max	Min		
SSTL-15 Class II	—	V <sub>REF</sub> - 0.1	V <sub>REF</sub> + 0.1	—	V <sub>REF</sub> - 0.175	V <sub>REF</sub> + 0.175	0.2 × V <sub>CCIO</sub>	0.8 × V <sub>CCIO</sub>	16	-16
HSTL-18 Class I	—	V <sub>REF</sub> - 0.1	V <sub>REF</sub> + 0.1	—	V <sub>REF</sub> - 0.2	V <sub>REF</sub> + 0.2	0.4	V <sub>CCIO</sub> - 0.4	8	-8
HSTL-18 Class II	—	V <sub>REF</sub> - 0.1	V <sub>REF</sub> + 0.1	—	V <sub>REF</sub> - 0.2	V <sub>REF</sub> + 0.2	0.4	V <sub>CCIO</sub> - 0.4	16	-16
HSTL-15 Class I	—	V <sub>REF</sub> - 0.1	V <sub>REF</sub> + 0.1	—	V <sub>REF</sub> - 0.2	V <sub>REF</sub> + 0.2	0.4	V <sub>CCIO</sub> - 0.4	8	-8
HSTL-15 Class II	—	V <sub>REF</sub> - 0.1	V <sub>REF</sub> + 0.1	—	V <sub>REF</sub> - 0.2	V <sub>REF</sub> + 0.2	0.4	V <sub>CCIO</sub> - 0.4	16	-16
HSTL-12 Class I	-0.15	V <sub>REF</sub> - 0.08	V <sub>REF</sub> + 0.08	V <sub>CCIO</sub> + 0.15	V <sub>REF</sub> - 0.15	V <sub>REF</sub> + 0.15	0.25 × V <sub>CCIO</sub>	0.75 × V <sub>CCIO</sub>	8	-8
HSTL-12 Class II	-0.15	V <sub>REF</sub> - 0.08	V <sub>REF</sub> + 0.08	V <sub>CCIO</sub> + 0.15	V <sub>REF</sub> - 0.15	V <sub>REF</sub> + 0.15	0.25 × V <sub>CCIO</sub>	0.75 × V <sub>CCIO</sub>	16	-16

Table 1–28 lists the differential SSTL I/O standards for Arria II GX devices.

**Table 1–28. Differential SSTL I/O Standards for Arria II GX Devices**

I/O Standard	V <sub>CCIO</sub> (V)			V <sub>SWING(DC)</sub> (V)		V <sub>X(AC)</sub> (V)			V <sub>SWING(AC)</sub> (V)		V <sub>OX(AC)</sub> (V)		
	Min	Typ	Max	Min	Max	Min	Typ	Max	Min	Max	Min	Typ	Max
SSTL-2 Class I, II	2.375	2.5	2.625	0.36	V <sub>CCIO</sub>	V <sub>CCIO</sub> /2 - 0.2	—	V <sub>CCIO</sub> /2 + 0.2	0.7	V <sub>CCIO</sub>	V <sub>CCIO</sub> /2 - 0.15	—	V <sub>CCIO</sub> /2 + 0.15
SSTL-18 Class I, II	1.71	1.8	1.89	0.25	V <sub>CCIO</sub>	V <sub>CCIO</sub> /2 - 0.175	—	V <sub>CCIO</sub> /2 + 0.175	0.5	V <sub>CCIO</sub>	V <sub>CCIO</sub> /2 - 0.125	—	V <sub>CCIO</sub> /2 + 0.125
SSTL-15 Class I, II	1.425	1.5	1.575	0.2	—	—	V <sub>CCIO</sub> /2	—	0.35	—	—	V <sub>CCIO</sub> /2	—

Table 1–29 lists the differential SSTL I/O standards for Arria II GZ devices

**Table 1–29. Differential SSTL I/O Standards for Arria II GZ Devices**

I/O Standard	V <sub>CCIO</sub> (V)			V <sub>SWING(DC)</sub> (V)		V <sub>X(AC)</sub> (V)			V <sub>SWING(AC)</sub> (V)		V <sub>OX(AC)</sub> (V)		
	Min	Typ	Max	Min	Max	Min	Typ	Max	Min	Max	Min	Typ	Max
SSTL-2 Class I, II	2.375	2.5	2.625	0.3	V <sub>CCIO</sub> + 0.6	V <sub>CCIO</sub> /2 - 0.2	—	V <sub>CCIO</sub> /2 + 0.2	0.62	V <sub>CCIO</sub> + 0.6	V <sub>CCIO</sub> /2 - 0.15	—	V <sub>CCIO</sub> /2 + 0.15
SSTL-18 Class I, II	1.71	1.8	1.89	0.25	V <sub>CCIO</sub> + 0.6	V <sub>CCIO</sub> /2 - 0.175	—	V <sub>CCIO</sub> /2 + 0.175	0.5	V <sub>CCIO</sub> + 0.6	V <sub>CCIO</sub> /2 - 0.125	—	V <sub>CCIO</sub> /2 + 0.125
SSTL-15 Class I, II	1.425	1.5	1.575	0.2	—	—	V <sub>CCIO</sub> /2	—	0.35	—	—	V <sub>CCIO</sub> /2	—

Table 1–33 lists the differential I/O standard specifications for Arria II GZ devices.

**Table 1–33. Differential I/O Standard Specifications for Arria II GZ Devices (Note 1)**

I/O Standard (2)	$V_{CCIO}$ (V)			$V_{ID}$ (mV)			$V_{ICM(DC)}$ (V)		$V_{OD}$ (V) (3)			$V_{OCM}$ (V) (3)		
	Min	Typ	Max	Min	Cond.	Max	Min	Max	Min	Typ	Max	Min	Typ	Max
2.5 V LVDS (HIO)	2.375	2.5	2.625	100	$V_{CM} = 1.25$ V	—	0.05	1.8	0.247	—	0.6	1.125	1.25	1.375
2.5 V LVDS (VIO)	2.375	2.5	2.625	100	$V_{CM} = 1.25$ V	—	0.05	1.8	0.247	—	0.6	1	1.25	1.5
RSDS (HIO)	2.375	2.5	2.625	100	$V_{CM} = 1.25$ V	—	0.3	1.4	0.1	0.2	0.6	0.5	1.2	1.4
RSDS (VIO)	2.375	2.5	2.625	100	$V_{CM} = 1.25$ V	—	0.3	1.4	0.1	0.2	0.6	0.5	1.2	1.5
Mini-LVDS (HIO)	2.375	2.5	2.625	200	—	600	0.4	1.32 <sub>5</sub>	0.25	—	0.6	1	1.2	1.4
Mini-LVDS (VIO)	2.375	2.5	2.625	200	—	600	0.4	1.32 <sub>5</sub>	0.25	—	0.6	1	1.2	1.5
LVPECL	2.375	2.5	2.625	300	—	—	0.6	1.8	—	—	—	—	—	—
BLVDS (4)	2.375	2.5	2.625	100	—	—	—	—	—	—	—	—	—	—

**Notes to Table 1–33:**

- (1) 1.4-V/1.5-V PCML transceiver I/O standard specifications are described in “Transceiver Performance Specifications” on page 1–21.
- (2) Vertical I/O (VIO) is top and bottom I/Os; horizontal I/O (HIO) is left and right I/Os.
- (3)  $R_L$  range:  $90 \leq R_L \leq 110 \Omega$ .
- (4) There are no fixed  $V_{ICM}$ ,  $V_{OD}$ , and  $V_{OCM}$  specifications for BLVDS. These specifications depend on the system topology.

## Power Consumption for the Arria II Device Family

Altera offers two ways to estimate power for a design:

- Using the Microsoft Excel-based Early Power Estimator
- Using the Quartus® II PowerPlay Power Analyzer feature

The interactive Microsoft Excel-based Early Power Estimator is typically used prior to designing the FPGA in order to get a magnitude estimate of the device power. The Quartus II PowerPlay Power Analyzer provides better quality estimates based on the specifics of the design after place-and-route is complete. The PowerPlay Power Analyzer can apply a combination of user-entered, simulation-derived, and estimated signal activities which, when combined with detailed circuit models, can yield very accurate power estimates.

 For more information about power estimation tools, refer to the *PowerPlay Early Power Estimator User Guide* and the *PowerPlay Power Analysis* chapter in volume 3 of the *Quartus II Handbook*.

## Switching Characteristics

This section provides performance characteristics of the Arria II GX and GZ core and periphery blocks for commercial grade devices. The following tables are considered final and are based on actual silicon characterization and testing. These numbers reflect the actual performance of the device under worst-case silicon process, voltage, and junction temperature conditions.

### Transceiver Performance Specifications

Table 1–34 lists the Arria II GX transceiver specifications.

**Table 1–34. Transceiver Specifications for Arria II GX Devices (Note 1) (Part 1 of 7)**

Symbol/ Description	Condition	I3			C4			C5 and I5			C6			Unit	
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
<b>Reference Clock</b>															
Supported I/O Standards	1.2-V PCML, 1.5-V PCML, 2.5-V PCML, Differential LVPECL, LVDS, and HCSL														
Input frequency from REFCLK input pins	—	50	—	622.08	50	—	622.08	50	—	622.08	50	—	622.08	MHz	
Input frequency from PLD input	—	50	—	200	50	—	200	50	—	200	50	—	200	MHz	
Absolute $V_{MAX}$ for a REFCLK pin	—	—	—	2.2	—	—	2.2	—	—	2.2	—	—	2.2	V	
Absolute $V_{MIN}$ for a REFCLK pin	—	-0.3	—	—	-0.3	—	—	-0.3	—	—	-0.3	—	—	V	
Rise/fall time (2)	—	—	—	0.2	—	—	0.2	—	—	0.2	—	—	0.2	UI	
Duty cycle	—	45	—	55	45	—	55	45	—	55	45	—	55	%	
Peak-to-peak differential input voltage	—	200	—	2000	200	—	2000	200	—	2000	200	—	2000	mV	
Spread-spectrum modulating clock frequency	PCIe	30	—	33	30	—	33	30	—	33	30	—	33	kHz	

Table 1–34. Transceiver Specifications for Arria II GX Devices **(Note 1)** (Part 3 of 7)

Symbol/ Description	Condition	I3			C4			C5 and I5			C6			Unit
		Min	Typ	Max										
fixedclk clock frequency	PCIe Receiver Detect	—	125	—	—	125	—	—	125	—	—	125	—	MHz
reconfig_clk clock frequency	Dynamic reconfig. clock frequency	2.5/ 37.5 <i>(4)</i>	—	50	MHz									
Delta time between reconfig_clks <i>(5)</i>	—	—	—	2	—	—	2	—	—	2	—	—	2	ms
Transceiver block minimum power-down pulse width	—	—	1	—	—	1	—	—	1	—	—	1	—	μs
<b>Receiver</b>														
Supported I/O Standards	1.4-V PCML, 1.5-V PCML, 2.5-V PCML, 2.5-V PCML, LVPECL, and LVDS													
Data rate <i>(13)</i>	—	600	—	6375	600	—	3750	600	—	3750	600	—	3125	Mbps
Absolute V <sub>MAX</sub> for a receiver pin <i>(6)</i>	—	—	—	1.5	—	—	1.5	—	—	1.5	—	—	1.5	V
Absolute V <sub>MIN</sub> for a receiver pin	—	-0.4	—	—	-0.4	—	—	-0.4	—	—	-0.4	—	—	V
Maximum peak-to-peak differential input voltage V <sub>ID</sub> (diff p-p)	V <sub>ICM</sub> = 0.82 V setting	—	—	2.7	—	—	2.7	—	—	2.7	—	—	2.7	V
	V <sub>ICM</sub> = 1.1 V setting <i>(7)</i>	—	—	1.6	—	—	1.6	—	—	1.6	—	—	1.6	V

Figure 1–3 shows the differential receiver input waveform.

**Figure 1–3. Receiver Input Waveform**

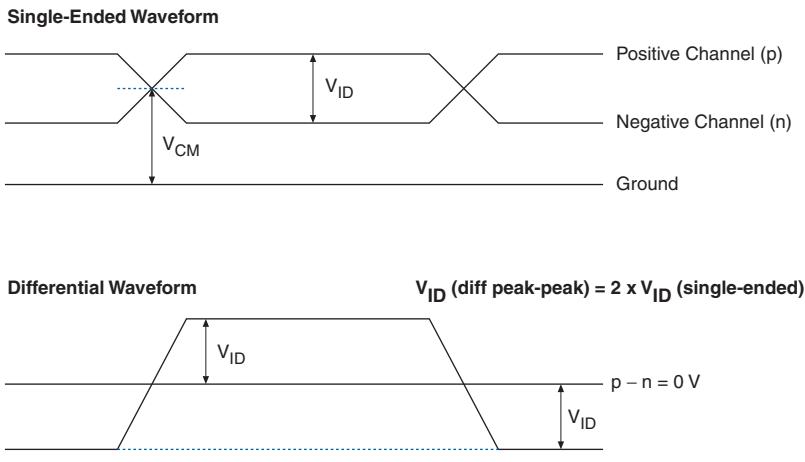


Figure 1–4 shows the transmitter output waveform.

**Figure 1–4. Transmitter Output Waveform**

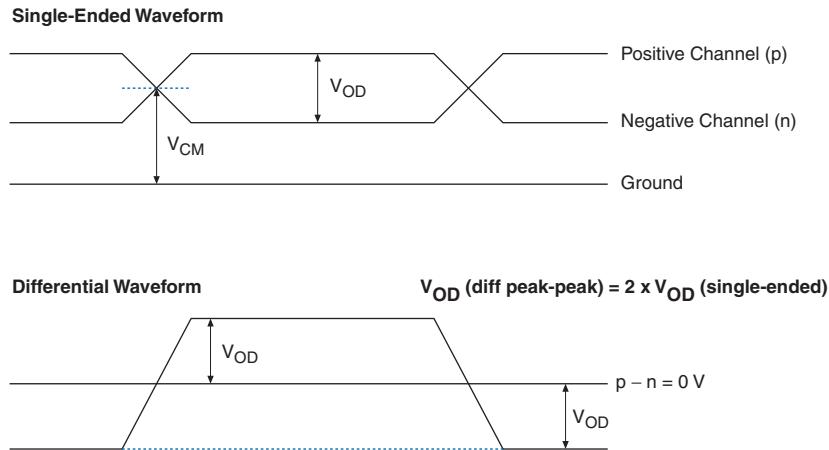


Table 1–36 lists the typical  $V_{OD}$  for TX term that equals 85  $\Omega$  for Arria II GZ devices.

**Table 1–36. Typical  $V_{OD}$  Setting, TX Term = 85  $\Omega$  for Arria II GZ Devices**

<b>Symbol</b>	<b><math>V_{OD}</math> Setting (mV)</b>							
	<b>0</b>	<b>1</b>	<b>2</b>	<b>3</b>	<b>4</b>	<b>5</b>	<b>6</b>	<b>7</b>
$V_{OD}$ differential peak-to-peak Typical (mV)	$170 \pm 20\%$	$340 \pm 20\%$	$510 \pm 20\%$	$595 \pm 20\%$	$680 \pm 20\%$	$765 \pm 20\%$	$850 \pm 20\%$	$1020 \pm 20\%$

**Table 1–39** lists typical transmitter pre-emphasis levels for Arria II GZ devices (in dB) for the first post tap under the following conditions (low-frequency data pattern [five 1s and five 0s] at 6.25 Gbps). The levels listed in **Table 1–39** are a representation of possible pre-emphasis levels under the specified conditions only and that the pre-emphasis levels may change with data pattern and data rate.

 To predict the pre-emphasis level for your specific data rate and pattern, run simulations using the [Arria II HSSI HSPICE](#) models.

**Table 1–39. Transmitter Pre-Emphasis Levels for Arria II GZ Devices (Part 1 of 2)**

Pre- Emphasis 1st Post-Tap Setting	V <sub>OD</sub> Setting							
	0	1	2	3	4	5	6	7
0	0	0	0	0	0	0	0	0
1	N/A	0.7	0	0	0	0	0	0
2	N/A	1	0.3	0	0	0	0	0
3	N/A	1.5	0.6	0	0	0	0	0
4	N/A	2	0.7	0.3	0	0	0	0
5	N/A	2.7	1.2	0.5	0.3	0	0	0
6	N/A	3.1	1.3	0.8	0.5	0.2	0	0
7	N/A	3.7	1.8	1.1	0.7	0.4	0.2	0
8	N/A	4.2	2.1	1.3	0.9	0.6	0.3	0
9	N/A	4.9	2.4	1.6	1.2	0.8	0.5	0.2
10	N/A	5.4	2.8	1.9	1.4	1	0.7	0.3
11	N/A	6	3.2	2.2	1.7	1.2	0.9	0.4
12	N/A	6.8	3.5	2.6	1.9	1.4	1.1	0.6
13	N/A	7.5	3.8	2.8	2.1	1.6	1.2	0.6
14	N/A	8.1	4.2	3.1	2.3	1.7	1.3	0.7
15	N/A	8.8	4.5	3.4	2.6	1.9	1.5	0.8
16	N/A	N/A	4.9	3.7	2.9	2.2	1.7	0.9
17	N/A	N/A	5.3	4	3.1	2.4	1.8	1.1
18	N/A	N/A	5.7	4.4	3.4	2.6	2	1.2
19	N/A	N/A	6.1	4.7	3.6	2.8	2.2	1.4
20	N/A	N/A	6.6	5.1	4	3.1	2.4	1.5
21	N/A	N/A	7	5.4	4.3	3.3	2.7	1.7
22	N/A	N/A	8	6.1	4.8	3.8	3	2
23	N/A	N/A	9	6.8	5.4	4.3	3.4	2.3
24	N/A	N/A	10	7.6	6	4.8	3.9	2.6
25	N/A	N/A	11.4	8.4	6.8	5.4	4.4	3
26	N/A	N/A	12.6	9.4	7.4	5.9	4.9	3.3
27	N/A	N/A	N/A	10.3	8.1	6.4	5.3	3.6
28	N/A	N/A	N/A	11.3	8.8	7.1	5.8	4

**Table 1–39. Transmitter Pre-Emphasis Levels for Arria II GZ Devices (Part 2 of 2)**

Pre- Emphasis 1st Post-Tap Setting	V <sub>OD</sub> Setting							
	0	1	2	3	4	5	6	7
29	N/A	N/A	N/A	12.5	9.6	7.7	6.3	4.3
30	N/A	N/A	N/A	N/A	11.4	9	7.4	N/A
31	N/A	N/A	N/A	N/A	12.9	10	8.2	N/A

Table 1–40 lists the transceiver jitter specifications for all supported protocols for Arria II GX devices.

**Table 1–40. Transceiver Block Jitter Specifications for Arria II GX Devices (Note 1) (Part 1 of 10)**

Symbol/ Description	Conditions	I3			C4			C5, I5			C6			Unit
		Min	Typ	Max										
<b>SONET/SDH Transmit Jitter Generation (2)</b>														
Peak-to-peak jitter at 622.08 Mbps	Pattern = PRBS15	—	—	0.1	—	—	0.1	—	—	0.1	—	—	0.1	UI
RMS jitter at 622.08 Mbps	Pattern = PRBS15	—	—	0.01	—	—	0.01	—	—	0.01	—	—	0.01	UI
Peak-to-peak jitter at 2488.32 Mbps	Pattern = PRBS15	—	—	0.1	—	—	0.1	—	—	0.1	—	—	0.1	UI
RMS jitter at 2488.32 Mbps	Pattern = PRBS15	—	—	0.01	—	—	0.01	—	—	0.01	—	—	0.01	UI
<b>SONET/SDH Receiver Jitter Tolerance (2)</b>														
Jitter tolerance at 622.08 Mbps	Jitter frequency = 0.03 KHz Pattern = PRBS15	> 15			> 15			> 15			> 15			UI
	Jitter frequency = 25 KHZ Pattern = PRBS15	> 1.5			> 1.5			> 1.5			> 1.5			UI
	Jitter frequency = 250 KHz Pattern = PRBS15	> 0.15			> 0.15			> 0.15			> 0.15			UI

**Table 1–40. Transceiver Block Jitter Specifications for Arria II GX Devices (*Note 1*) (Part 6 of 10)**

Symbol/ Description	Conditions	I3			C4			C5, I5			C6			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Sinusoidal jitter tolerance (peak-to-peak)	Jitter frequency = 20 KHz  Data rate = 1.485 Gbps (HD) Pattern = 75% color bar	> 1			> 1			> 1			> 1			UI
	Jitter frequency = 100 KHz  Data rate = 1.485 Gbps (HD) Pattern = 75% color bar	> 0.2			> 0.2			> 0.2			> 0.2			UI
	Jitter frequency = 148.5 MHz  Data rate = 1.485 Gbps (HD) Pattern = 75% color bar	> 0.2			> 0.2			> 0.2			> 0.2			UI

**SATA Transmit Jitter Generation (10)**

Total jitter at 1.5 Gbps (G1)	Compliance pattern	—	—	0.55	—	—	0.55	—	—	0.55	—	—	0.55	UI
Deterministic jitter at 1.5 Gbps (G1)	Compliance pattern	—	—	0.35	—	—	0.35	—	—	0.35	—	—	0.35	UI
Total jitter at 3.0 Gbps (G2)	Compliance pattern	—	—	0.55	—	—	0.55	—	—	0.55	—	—	0.55	UI
Deterministic jitter at 3.0 Gbps (G2)	Compliance pattern	—	—	0.35	—	—	0.35	—	—	0.35	—	—	0.35	UI
Total jitter at 6.0 Gbps (G3)	Compliance pattern	—	—	0.52	—	—	—	—	—	—	—	—	—	UI
Random jitter at 6.0 Gbps (G3)	Compliance pattern	—	—	0.18	—	—	—	—	—	—	—	—	—	UI

**SATA Receiver Jitter Tolerance (10)**

Total jitter tolerance at 1.5 Gbps (G1)	Compliance pattern	> 0.65			> 0.65			> 0.65			> 0.65			UI
Deterministic jitter tolerance at 1.5 Gbps (G1)	Compliance pattern	> 0.35			> 0.35			> 0.35			> 0.35			UI
SSC modulation frequency at 1.5 Gbps (G1)	Compliance pattern	33			33			33			33			kHz

**Table 1–40. Transceiver Block Jitter Specifications for Arria II GX Devices (*Note 1*) (Part 8 of 10)**

Symbol/ Description	Conditions	I3			C4			C5, I5			C6			Unit
		Min	Typ	Max										
<b>CPRI Transmit Jitter Generation (11)</b>														
Total jitter	E.6.HV, E.12.HV Pattern = CJPAT	—	—	0.279	—	—	0.279	—	—	0.279	—	—	0.279	UI
	E.6.LV, E.12.LV, E.24.LV, E.30.LV Pattern = CJTPAT	—	—	0.35	—	—	0.35	—	—	0.35	—	—	0.35	UI
Deterministic jitter	E.6.HV, E.12.HV Pattern = CJPAT	—	—	0.14	—	—	0.14	—	—	0.14	—	—	0.14	UI
	E.6.LV, E.12.LV, E.24.LV, E.30.LV Pattern = CJTPAT	—	—	0.17	—	—	0.17	—	—	0.17	—	—	0.17	UI
<b>CPRI Receiver Jitter Tolerance (11)</b>														
Total jitter tolerance	E.6.HV, E.12.HV Pattern = CJPAT	> 0.66			> 0.66			> 0.66			> 0.66			UI
Deterministic jitter tolerance	E.6.HV, E.12.HV Pattern = CJPAT	> 0.4			> 0.4			> 0.4			> 0.4			UI
Total jitter tolerance	E.6.LV, E.12.LV, E.24.LV, E.30.LV Pattern = CJTPAT	> 0.65			> 0.65			> 0.65			> 0.65			UI
	E.60.LV Pattern = PRBS31	> 0.6			—			—			—			UI
Deterministic jitter tolerance	E.6.LV, E.12.LV, E.24.LV, E.30.LV Pattern = CJTPAT	> 0.37			> 0.37			> 0.37			> 0.37			UI
	E.60.LV Pattern = PRBS31	> 0.45			—			—			—			UI
Combined deterministic and random jitter tolerance	E.6.LV, E.12.LV, E.24.LV, E.30.LV Pattern = CJTPAT	> 0.55			> 0.55			> 0.55			> 0.55			UI
<b>OBSAI Transmit Jitter Generation (12)</b>														
Total jitter at 768 Mbps, 1536 Mbps, and 3072 Mbps	REFCLK = 153.6 MHz Pattern = CJPAT	—	—	0.35	—	—	0.35	—	—	0.35	—	—	0.35	UI
Deterministic jitter at 768 Mbps, 1536 Mbps, and 3072 Mbps	REFCLK = 153.6 MHz Pattern = CJPAT	—	—	0.17	—	—	0.17	—	—	0.17	—	—	0.17	UI

**Table 1–41. Transceiver Block Jitter Specifications for Arria II GZ Devices (Note 1), (2) (Part 2 of 7)**

Symbol/ Description	Conditions	–C3 and –I3			–C4 and –I4			Unit
		Min	Typ	Max	Min	Typ	Max	
Jitter tolerance at 2488.32 Mbps	Jitter frequency = 0.06 KHz Pattern = PRBS15	> 15		> 15		> 15		UI
	Jitter frequency = 100 KHZ Pattern = PRBS15	> 1.5		> 1.5		> 1.5		UI
	Jitter frequency = 1 MHz Pattern = PRBS15	> 0.15		> 0.15		> 0.15		UI
	Jitter frequency = 10 MHz Pattern = PRBS15	> 0.15		> 0.15		> 0.15		UI
<b>Fibre Channel Transmit Jitter Generation (4), (5)</b>								
Total jitter FC-1	Pattern = CRPAT	—	—	0.23	—	—	0.23	UI
Deterministic jitter FC-1	Pattern = CRPAT	—	—	0.11	—	—	0.11	UI
Total jitter FC-2	Pattern = CRPAT	—	—	0.33	—	—	0.33	UI
Deterministic jitter FC-2	Pattern = CRPAT	—	—	0.2	—	—	0.2	UI
Total jitter FC-4	Pattern = CRPAT	—	—	0.52	—	—	0.52	UI
Deterministic jitter FC-4	Pattern = CRPAT	—	—	0.33	—	—	0.33	UI
<b>Fibre Channel Receiver Jitter Tolerance (4), (6)</b>								
Deterministic jitter FC-1	Pattern = CJTPAT	> 0.37		> 0.37		> 0.37		UI
Random jitter FC-1	Pattern = CJTPAT	> 0.31		> 0.31		> 0.31		UI
Sinusoidal jitter FC-1	Fc/25000	> 1.5		> 1.5		> 1.5		UI
	Fc/1667	> 0.1		> 0.1		> 0.1		UI
Deterministic jitter FC-2	Pattern = CJTPAT	> 0.33		> 0.33		> 0.33		UI
Random jitter FC-2	Pattern = CJTPAT	> 0.29		> 0.29		> 0.29		UI
Sinusoidal jitter FC-2	Fc/25000	> 1.5		> 1.5		> 1.5		UI
	Fc/1667	> 0.1		> 0.1		> 0.1		UI
Deterministic jitter FC-4	Pattern = CJTPAT	> 0.33		> 0.33		> 0.33		UI
Random jitter FC-4	Pattern = CJTPAT	> 0.29		> 0.29		> 0.29		UI
Sinusoidal jitter FC-4	Fc/25000	> 1.5		> 1.5		> 1.5		UI
	Fc/1667	> 0.1		> 0.1		> 0.1		UI
<b>XAU1 Transmit Jitter Generation (7)</b>								
Total jitter at 3.125 Gbps	Pattern = CJPAT	—	—	0.3	—	—	0.3	UI
Deterministic jitter at 3.125 Gbps	Pattern = CJPAT	—	—	0.17	—	—	0.17	UI
<b>XAU1 Receiver Jitter Tolerance (7)</b>								
Total jitter	—	> 0.65		> 0.65		> 0.65		UI
Deterministic jitter	—	> 0.37		> 0.37		> 0.37		UI

**Table 1–41. Transceiver Block Jitter Specifications for Arria II GZ Devices (Note 1), (2) (Part 3 of 7)**

Symbol/ Description	Conditions	–C3 and –I3			–C4 and –I4			Unit
		Min	Typ	Max	Min	Typ	Max	
Peak-to-peak jitter	Jitter frequency = 22.1 KHz	> 8.5		> 8.5		> 8.5		UI
Peak-to-peak jitter	Jitter frequency = 1.875 MHz	> 0.1		> 0.1		> 0.1		UI
Peak-to-peak jitter	Jitter frequency = 20 MHz	> 0.1		> 0.1		> 0.1		UI
<b>PCIe Transmit Jitter Generation (8)</b>								
Total jitter at 2.5 Gbps (Gen1)—x1, x4, and x8	Compliance pattern	—	—	0.25	—	—	0.25	UI
Total jitter at 5 Gbps (Gen2)—x1, x4, and x8	Compliance pattern	—	—	0.25	—	—	—	UI
<b>PCIe Receiver Jitter Tolerance (8)</b>								
Total jitter at 2.5 Gbps (Gen1)	Compliance pattern	> 0.6		> 0.6		UI		UI
Total jitter at 5 Gbps (Gen2)	Compliance pattern	Not supported		Not supported		UI		UI
<b>PCIe (Gen 1) Electrical Idle Detect Threshold</b>								
V <sub>RX-IDLE-DETDIFFp-p</sub> (9)	Compliance pattern	65	—	175	65	—	175	UI
<b>SRIO Transmit Jitter Generation (10)</b>								
Deterministic jitter (peak-to-peak)	Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	—	—	0.17	—	—	0.17	UI
Total jitter (peak-to-peak)	Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	—	—	0.35	—	—	0.35	UI
<b>SRIO Receiver Jitter Tolerance (10)</b>								
Deterministic jitter tolerance (peak-to-peak)	Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	> 0.37		> 0.37		UI		UI
Combined deterministic and random jitter tolerance (peak-to-peak)	Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	> 0.55		> 0.55		UI		UI
Sinusoidal jitter tolerance (peak-to-peak)	Jitter frequency = 22.1 KHz Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	> 8.5		> 8.5		UI		UI
	Jitter frequency = 1.875 MHz Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	> 0.1		> 0.1		UI		UI
	Jitter frequency = 20 MHz Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	> 0.1		> 0.1		UI		UI
<b>GIGE Transmit Jitter Generation (11)</b>								
Deterministic jitter (peak-to-peak)	Pattern = CRPAT	—	—	0.14	—	—	0.14	UI
Total jitter (peak-to-peak)	Pattern = CRPAT	—	—	0.279	—	—	0.279	UI

**Table 1–44. PLL Specifications for Arria II GX Devices (Part 2 of 3)**

<b>Symbol</b>	<b>Description</b>	<b>Min</b>	<b>Typ</b>	<b>Max</b>	<b>Unit</b>
$f_{\text{OUT}}$	Output frequency for internal global or regional clock (-4 Speed Grade)	—	—	500	MHz
	Output frequency for internal global or regional clock (-5 Speed Grade)	—	—	500	MHz
	Output frequency for internal global or regional clock (-6 Speed Grade)	—	—	400	MHz
$f_{\text{OUT\_EXT}}$	Output frequency for external clock output (-4 Speed Grade)	—	—	670 (5)	MHz
	Output frequency for external clock output (-5 Speed Grade)	—	—	622 (5)	MHz
	Output frequency for external clock output (-6 Speed Grade)	—	—	500 (5)	MHz
$t_{\text{OUTDUTY}}$	Duty cycle for external clock output (when set to 50%)	45	50	55	%
$t_{\text{OUTPJ\_DC}}$	Dedicated clock output period jitter ( $f_{\text{OUT}} \geq 100$ MHz)	—	—	300	ps (p-p)
	Dedicated clock output period jitter ( $f_{\text{OUT}} < 100$ MHz)	—	—	30	mUI (p-p)
$t_{\text{OUTCCJ\_DC}}$	Dedicated clock output cycle-to-cycle jitter ( $f_{\text{OUT}} \geq 100$ MHz)	—	—	300	ps (p-p)
	Dedicated clock output cycle-to-cycle jitter ( $f_{\text{OUT}} < 100$ MHz)	—	—	30	mUI (p-p)
$f_{\text{OUTPJ\_IO}}$	Regular I/O clock output period jitter ( $f_{\text{OUT}} \geq 100$ MHz)	—	—	650	ps (p-p)
	Regular I/O clock output period jitter ( $f_{\text{OUT}} < 100$ MHz)	—	—	65	mUI (p-p)
$f_{\text{OUTCCJ\_IO}}$	Regular I/O clock output cycle-to-cycle jitter ( $f_{\text{OUT}} \geq 100$ MHz)	—	—	650	ps (p-p)
	Regular I/O clock output cycle-to-cycle jitter ( $f_{\text{OUT}} < 100$ MHz)	—	—	65	mUI (p-p)
$t_{\text{CONFIGPLL}}$	Time required to reconfigure PLL scan chains	—	3.5	—	SCANCLK cycles
$t_{\text{CONFIGPHASE}}$	Time required to reconfigure phase shift	—	1	—	SCANCLK cycles
$f_{\text{SCANCLK}}$	SCANCLK frequency	—	—	100	MHz
$t_{\text{LOCK}}$	Time required to lock from end of device configuration	—	—	1	ms
$t_{\text{DLLOCK}}$	Time required to lock dynamically (after switchover or reconfiguring any non-post-scale counters/delays)	—	—	1	ms
$f_{\text{CLBW}}$	PLL closed-loop low bandwidth	—	0.3	—	MHz
	PLL closed-loop medium bandwidth	—	1.5	—	MHz
	PLL closed-loop high bandwidth	—	4	—	MHz
$t_{\text{PLL\_PSERR}}$	Accuracy of PLL phase shift	—	—	$\pm 50$	ps
$t_{\text{ARESET}}$	Minimum pulse width on areset signal	10	—	—	ns

**Table 1–53. High-Speed I/O Specifications for Arria II GX Devices (Part 2 of 4)**

<b>Symbol</b>	<b>Conditions</b>	<b>I3</b>		<b>C4</b>		<b>C5,I5</b>		<b>C6</b>		<b>Unit</b>
		<b>Min</b>	<b>Max</b>	<b>Min</b>	<b>Max</b>	<b>Min</b>	<b>Max</b>	<b>Min</b>	<b>Max</b>	
<b>Transmitter</b>										
$f_{HSDR\_TX}$ (true LVDS output data rate)	SERDES factor, J = 3 to 10 (using dedicated SERDES)	150	1250 (2)	150	1250 (2)	150	1050 (2)	150	840	Mbps
	SERDES factor, J = 4 to 10 (using logic elements as SERDES)	(3)	945	(3)	945	(3)	840	(3)	740	Mbps
	SERDES factor, J = 2 (using DDR registers) and J = 1 (using SDR register)	(3)	(3)	(3)	(3)	(3)	(3)	(3)	(3)	Mbps
$f_{HSDR\_TX\_E3R}$ (emulated LVDS_E_3R output data rate) (7)	SERDES factor, J = 4 to 10	(3)	945	(3)	945	(3)	840	(3)	740	Mbps

Table 1–60 lists the DQS phase shift error for Arria II GX devices.

**Table 1–60. DQS Phase Shift Error Specification for DLL-Delayed Clock ( $t_{DQS\_PSERR}$ ) for Arria II GX Devices (Note 1)**

Number of DQS Delay Buffer	C4	I3, C5, I5	C6	Unit
1	26	30	36	ps
2	52	60	72	ps
3	78	90	108	ps
4	104	120	144	ps

**Note to Table 1–60:**

- (1) This error specification is the absolute maximum and minimum error. For example, skew on three DQS delay buffers in a C4 speed grade is  $\pm 78$  ps or  $\pm 39$  ps.

Table 1–61 lists the DQS phase shift error for Arria II GZ devices.

**Table 1–61. DQS Phase Shift Error Specification for DLL-Delayed Clock ( $t_{DQS\_PSERR}$ ) for Arria II GZ Devices (Note 1)**

Number of DQS Delay Buffer	-3	-4	Unit
1	28	30	ps
2	56	60	ps
3	84	90	ps
4	112	120	ps

**Note to Table 1–61:**

- (1) This error specification is the absolute maximum and minimum error. For example, skew on three DQS delay buffers in a 3 speed grade is  $\pm 84$  ps or  $\pm 42$  ps.

Table 1–62 lists the memory output clock jitter specifications for Arria II GX devices.

**Table 1–62. Memory Output Clock Jitter Specification for Arria II GX Devices (Note 1), (2), (3)**

Parameter	Clock Network	Symbol	-4		-5		-6		Unit
			Min	Max	Min	Max	Min	Max	
Clock period jitter	Global	$t_{JIT(per)}$	-100	100	-125	125	-125	125	ps
Cycle-to-cycle period jitter	Global	$t_{JIT(cc)}$	-200	200	-250	250	-250	250	ps
Duty cycle jitter	Global	$t_{JIT(duty)}$	-100	100	-125	125	-125	125	ps

**Notes to Table 1–62:**

- (1) The memory output clock jitter measurements are for 200 consecutive clock cycles, as specified in the JEDEC DDR2/DDR3 SDRAM standard.  
(2) The clock jitter specification applies to memory output clock pins generated using DDIO circuits clocked by a PLL output routed on a global clock network.  
(3) The memory output clock jitter stated in Table 1–62 is applicable when an input jitter of 30 ps is applied.